

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2152	solder\$4 and (solder\$4 or print\$4) near (mask or stencil or template) and (pad or contact or electrode or terminal) and solder near (ball or bump) and (melt\$4 or reflow)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:49
L2	120	1 and solder near (split or splitt\$4 or division or divid\$4 or separat\$4 or seperat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:47
L3	1613	solder near (split or splitt\$4 or division or divid\$4 or separat\$4 or seperat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:42
L4	945	3 and (mask or stencil or template or print\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:42
L5	825	4 not 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:44
L6	22	liquid adj prime adj mover	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:46
L7	1	4 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:46
L8	1	6 and solder near (split or splitt\$4 or division or divid\$4 or separat\$4 or seperat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:47

L9	4825	solder\$4 and solder\$4 near (print\$4 or cream or paste or mask or stencil or template) and (pad or contact or electrode or terminal) and solder near (ball or bump) and (melt\$4 or reflow)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:51
L10	842	9 and (pwb or wiring adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:51
L11	770	9 and (electroptical or led or lcd or liquid adj crystal or diode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:52
L12	3380	9 not (10 or 11)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:55
L13	1164	12	US-PGPUB	OR	ON	2005/09/14 12:58
L14	1892	12	USPAT	OR	ON	2005/09/14 12:55
L15	0	12 not (13 or 14)	USPAT	OR	ON	2005/09/14 12:55
L16	324	12	USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:56
L17	1	"20020153092" and mask	US-PGPUB	OR	ON	2005/09/14 12:58

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L1	2152	solder\$4 and (solder\$4 or print\$4) near (mask or stencil or template) and (pad or contact or electrode or terminal) and solder near (ball or bump) and (melt\$4 or reflow)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 11:34
L2	120	1 and solder near (split or splitt\$4 or division or divid\$4 or separat\$4 or seperat\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 12:21